

IPC-7711C/7721C
CIS Certification/Recertification Course Schedule
(All modules course time 32.5 Hrs)

Hour		Module 1 (Required)		Module 2 Wire Splice	Module 3 Coating	Module 4 Through Hole
		Total: 6 hours		Total: 3 hours	Total: 2 hours	Total: 5.25 hours
1	0.25	Intro Lecture 0.5 hr.	Additional> Modules>	M2 – Lecture 0.5 hrs. Wire Splices	M3 – Lecture 0.75 hr. Coating Removal	M4 – PTH Lecture .75 hr. Through Hole
	0.25	Welcome and Introductions				
	0.25					
	0.25					
2	0.25	P&P Lecture 1.5 hr.		M2 – Demo/Lab 2.5 hrs. Wire Splice	M3-Demo/Lab 1.25 hr. Coating Removal	M4 – Demo/Lab 4.5 hr. Through Hole
	0.25	Policies and Procedures				
	0.25					
	0.25					
3	0.25					
	0.25					
	0.25					
	0.25					
4	0.25	Lecture 3.0 hrs. Common Procedures				
	0.25					
	0.25					
	0.25					
5	0.25					
	0.25					
	0.25					
	0.25					
6	0.25	Open Book Exam 1.0 hr				
	0.25					
	0.25					
	0.25					
7	0.25					
	0.25					
	0.25					
	0.25					
8	0.25					
	0.25					
	0.25					
	0.25					

IPC-7711C/7721C

CIS Certification/Recertification Course Schedule (Additional Modules Continued)

Hour		Module 5 Chip/Melf	Module 6 Gull Wing	Module 7 J-Lead	Module 8 BGA	Module 9 Laminate Repair	Module 10 Circuit Repair
		Total: 3.25 hours	Total: 5 hours	Total: 2 hours	Total: .5 hours Lecture	Total: 2 hours	Total: 3.5 hours
1	0.25	M5 – Lecture .75 hr. Chip and MELF	M6 – Lecture 1.0 hr. Gull Wing (SOT, SOIC, D-Pak, QFP)	M7 – Lecture .5 hr. J-Lead	M8 – Lecture .5 hr. BGA	M9 – Lecture .5 hr. Laminate Repair	M10 – Lecture .75 hr. Circuit Repair
	0.25			M5 – Demo/Lab 2.5 hr. Chip and MELF			
	0.25	M6 – Demo/Lab 4.0 hr. Gull Wing (SOT, SOIC, D-Pak, QFP)			M10 – Demo/Lab 2.75 hr. Circuit Repair		
	0.25						
2	0.25						
	0.25						
	0.25						
3	0.25						
	0.25						
	0.25						
4	0.25						
	0.25						
	0.25						
5	0.25						
	0.25						
	0.25						
6	0.25						
	0.25						
	0.25						
7	0.25						
	0.25						
	0.25						
8	0.25						
	0.25						
	0.25						